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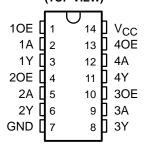
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic Small-Outline (D) and Shrink Small-Outline (DB) Packages, Ceramic Chip Carriers (FK), and Plastic (N) and Ceramic (J) DIPs

description

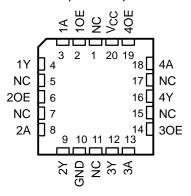
The 'ABT126 bus buffer gates feature independent line drivers with 3-state outputs. Each output is disabled when the associated output-enable (OE) input is low.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ABT126 . . . J PACKAGE SN74ABT126 . . . D, DB, OR N PACKAGE (TOP VIEW)



SN54ABT126 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ABT126 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT126 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT				
OE	Α	Y				
Н	Н	Н				
Н	L	L				
L	Х	Z				



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

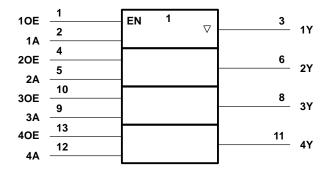
EPIC-IIB is a trademark of Texas Instruments Incorporated.



SN54ABT126, SN74ABT126 **QUADRUPLE BUS BUFFER GATES** WITH 3-STATE OUTPUTS

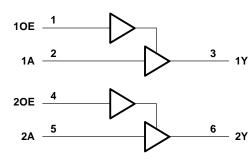
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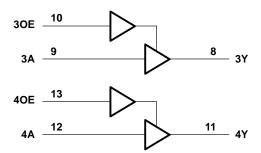
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, J, and N packages.

logic diagram (positive logic)





Pin numbers shown are for the D, DB, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO0).5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT126	96 mA
SN74ABT126	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): D package	127°C/W
DB package	158°C/W
N package	78°C/W
Storage temperature range, T _{stq}	5°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stressratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.



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recommended operating conditions (see Note 3)

		SN54ABT126		SN74ABT126		
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	Ź	2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	Vcc	0	VCC	V
loh	High-level output current	1	-24		-32	mA
loL	Low-level output current	2	48		64	mA
Δt/Δν	Input transition rise or fall rate	30/	10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate	200		200		μs/V
T _A	Operating free-air temperature	- 55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A = 25°C			SN54ABT126		SN74ABT126		UNIT
PARAMETER			MIN	TYP [†]	MAX	MIN	MAX	MIN	MAX	UNII
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2		-1.2		-1.2	V
	V _{CC} = 4.5 V,	IOH = -3 mA	2.5			2.5		2.5		
Vari	V _{CC} = 5 V,	I _{OH} = -3 mA	3			3		3		V
VOH	V 45V	I _{OH} = -24 mA	2			2) v
	V _{CC} = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
Val	V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55		0.55			٧
VOL	VCC = 4.3 V	I _{OL} = 64 mA			0.55*				0.55	٧
V_{hys}				100			2			mV
lį	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1		±1		±1	μΑ
lozpu [‡]	$V_{CC} = 0 \text{ to } 2.1 \text{ V}, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, OE = X$				±50		±50		±50	μΑ
IOZPD [‡]	$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 2.7 \text{ V, OE} = X$				±50	4	±50		±50	μΑ
lozh	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, V_{O} = 2.7 \text{ V}, \text{ OE} \le 0.8 \text{ V}$				10	3	10		10	μΑ
lozL	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, V_{O} = 0.5 \text{ V}, OE \le 0.8 \text{ V}$				-10	90	-10		-10	μΑ
l _{off}	$V_{CC} = 0$, $V_{I} \text{ or } V_{O} \le 4.5 \text{ V}$				±100	y _q			±100	μΑ
ICEX	$V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$	Outputs high			50		50		50	μΑ
ΙΟ [¶]	$V_{CC} = 5.5 V,$	V _O = 2.5 V	-50	-100	-200	-50	-200	-50	-200	mA
	.,,	Outputs high		1	250		250		250	μΑ
ICC	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low		24	30		30		30	mA
		Outputs disabled		0.5	250		250		250	μΑ
Aloo#	V _{CC} = 5.5 V, One input at 3.4 V,	Outputs enabled			1.5		1.5		1.5	mA
∆l _{CC} #	Other inputs at V _{CC} or GND	Outputs disabled			50		50		50	μΑ
C _i	V _I = 2.5 V or 0.5 V			3						pF
Co	V _O = 2.5 V or 0.5 V			7						pF

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

[#]This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] This parameter is characterized, but not production tested.

[§] For VCC between 2.1 V and 4 V, OE should be less than or equal to 0.5 V to ensure a low state.

[¶] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

SN54ABT126, SN74ABT126 QUADRUPLE BUS BUFFER GATES WITH 3-STATE OUTPUTS

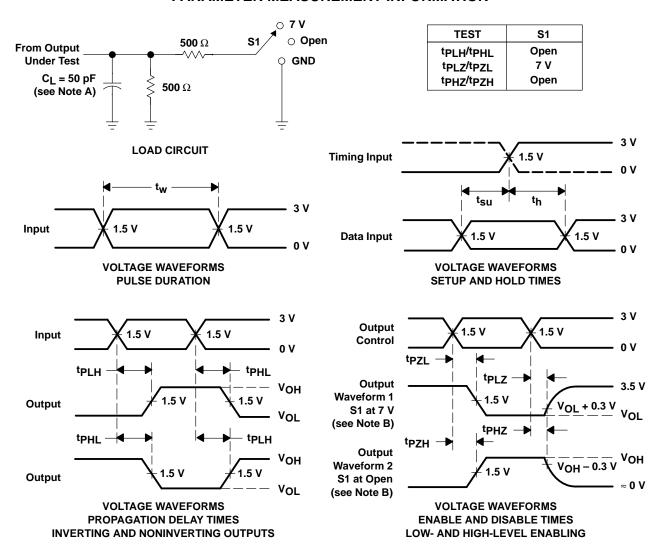
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			SN54ABT126		SN74ABT126		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	А	A Y	1	2.9	4.9	1	7.3	1	6.3	ns
^t PHL			1	2.5	5.1	1	5.9	1	5.7	
^t PZH	OE	Y	1	4.4	5.8	1,	5.3	1	6.5	l ns I
^t PZL			1	4.4	5.9	3	6.4	1	6.5	
^t PHZ	OE	- V	1	3	5.7	0 1	6.9	1	6.8	
t _{PLZ}		r	1	3	5.8	Q 1	7.2	1	6.7	ns

NOTE 4: Limits may vary among suppliers.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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